

EAST Search History**EAST Search History (Prior Art)**

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L10	28	("4157932" "4749120" "4811081" "4855808" "4859268" "4918504" "4922321" "4963002" "5117300" "5196371" "5242511" "5264467" "5445308").PN. OR ("5846853").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2011/03/24 20:57
S111	1	"5167729".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2010/03/29 14:29
S112	1	"6915944".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2010/03/29 14:32
S113	14	("4479983" "4789411" "4940498" "5004509" "5128746" "5211763" "5904782" "5907007" "6228678" "6340113" "6592020").PN. OR ("6915944").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2010/03/29 15:03

EAST Search History (I nterference)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp

L2	6	yoshiyuki near3 wada. in. and (ic chip semiconductor ((electrical electronic) near4 (part component device element))) and adhesive with solder\$3	US- PGPUB; USPAT; UPAD	OR	ON	2011/03/24 20:27
L3	12	tadahiko near2 sakai. in. and (ic chip semiconductor ((electrical electronic) near4 (part component device element))) and adhesive with solder\$3 not 2	US- PGPUB; USPAT; UPAD	OR	ON	2011/03/24 20:28
L4	4	("20090097214" "6158115" "6479757" "6841022").PN. OR ("7845074").URPN.	US- PGPUB; USPAT	OR	ON	2011/03/24 20:31
L5	7	("20010018796" "20030068906" "5830389" "5837119" "6262408" "6498051" "7084008").PN. OR ("7886432").URPN.	US- PGPUB; USPAT	OR	ON	2011/03/24 20:32
L6	5	("5631191" "5810959" "5943558").PN. OR ("6498051").URPN.	US- PGPUB; USPAT	OR	ON	2011/03/24 20:33
L7	186	(solder sn\$1bi) with (epoxy resin thermosetting underfill encapsulant) with (mix \$3 mixture blend\$3) and (solder sn\$1bi) with (reflow\$3 melt\$3) same (cure curing cured) with (epoxy resin thermosetting underfill encapsulant)	US- PGPUB; USPAT; UPAD	OR	ON	2011/03/24 20:35
L8	100	("3401126" "3429040" "5315155" "5343076").PN. OR ("5629566").URPN.	US- PGPUB; USPAT	OR	ON	2011/03/24 20:50

L9	22	("4903118" "5442240" "5629566" "5734201" "5801435" "5805422" "5818113").PN. OR ("5959362").URPN.	US- PGPUB; USPAT	OR	ON	2011/03/24 20:56
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3/ 24/ 11 8:59:41 PM

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\ 10590473 ECM adhesive.wsp**